



60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D Max T _C = +25°C (Note 7) |
|-------------------|--------------------------------|--|
| 60V | 3.1mΩ @ V _{GS} = 10V | 100A |
| 60 V | 4.5mΩ @ V _{GS} = 4.5V | 100A |

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Primary switches in isolated DC-DC
- Synchronous rectifiers
- Load switches

Features

- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Qg Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

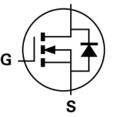
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

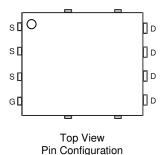
Site 1:



Pin 1



Internal Schematic

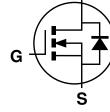


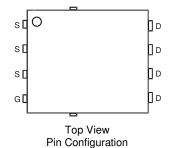
Top View **Bottom View**

Site 2:

PowerDI5060-8/SWP (Type UX)







Top View

Bottom View

Internal Schematic

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



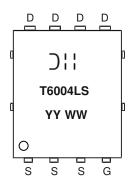
Ordering Information (Note 4)

| Part Number | Package | Packing | | |
|---------------|-----------------------------|---------|-------------|--|
| Fait Number | rackage | Qty. | Carrier | |
| DMT6004LPS-13 | PowerDI5060-8 | 2,500 | Tape & Reel | |
| DM16004LF3-13 | PowerDI5060-8/SWP (Type UX) | 2,500 | Tape & Reel | |

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





⊃¦¦ = Manufacturer's Marking T6004LS = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 23 = 2023) WW = Week (01 to 53)

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|---|--|------------------|------------|------|
| Drain-Source Voltage | | VDSS | 60 | V |
| Gate-Source Voltage | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 5) | T _A = +25°C T _A = +70°C | lo | 22 16 | А |
| Continuous Drain Current (Notes 6 & 7) | $T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$ | lo | 100 100 | Α |
| Maximum Continuous Body Diode Forward Current (Note 6) | | ls | 100 | Α |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | I _{DM} | 400 | Α |
| Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%) | | Ism | 400 | Α |
| Avalanche Current, L = 0.2mH | | las | 40 | Α |
| Avalanche Energy, L = 0.2mH | | Eas | 160 | mJ |

Thermal Characteristic

| Characteristic | | Symbol | Value | Unit |
|--|------------------------|----------|-------------|------|
| Total Power Dissipation (Note 5) | T _A = +25°C | PD | 2.5 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | | Reja | 47 | °C/W |
| Total Power Dissipation (Note 6) | T _C = +25°C | PD | 139 | W |
| Thermal Resistance, Junction to Case (Note 6) | | Rejc | 0.9 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C |

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. Limited by package.



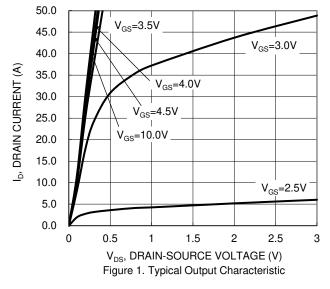
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|---|----------------------------------|-----|------|------|------|--|
| OFF CHARACTERISTICS (Note 8) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | _ | _ | V | VGS = 0V, ID = 1mA |
| Zero Gate Voltage Drain Current | IDSS | 1 | _ | 1 | μA | V _{DS} = 48V, V _{GS} = 0V |
| Gate-Source Leakage | Igss | ı | - | ±100 | nA | $V_{GS} = \pm 20V$, $V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 8) | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 1 | - | 3 | V | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ |
| Static Drain-Source On-Resistance | Dag (a) | 1 | 2.5 | 3.1 | mΩ | $V_{GS} = 10V, I_D = 25A$ |
| Static Drain-Source On-Resistance | R _{DS(ON)} | 1 | 3.3 | 4.5 | mΩ | $V_{GS} = 4.5V, I_D = 20A$ |
| Diode Forward Voltage | V _{SD} | _ | _ | 1.3 | V | V _{GS} = 0V, I _S = 25A |
| DYNAMIC CHARACTERISTICS (Note 9) | DYNAMIC CHARACTERISTICS (Note 9) | | | | | |
| Input Capacitance | Ciss | 1 | 5399 | _ | | V 00V V 0V |
| Output Capacitance | Coss | 1 | 1306 | _ | pF | $V_{DS} = 30V$, $V_{GS} = 0V$ f = 1MHz |
| Reverse Transfer Capacitance | Crss | | 92 | _ | | |
| Gate Resistance | Rg | _ | 0.64 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ |
| Total Gate Charge (V _{GS} = 10V) | Qg | 1 | 78.3 | _ | | |
| Total Gate Charge (VGS = 4.5V) | Qg | ı | 38.5 | _ | nC | V _{DD} = 30V. I _D = 25A |
| Gate-Source Charge | Qgs | ı | 10.2 | _ | IIC | VDD = 30V, ID = 25A |
| Gate-Drain Charge | Q_{gd} | | 20.4 | _ | | |
| Turn-On Delay Time | td(ON) | _ | 9.9 | _ | | |
| Turn-On Rise Time | tr | _ | 17.7 | _ | l | $\begin{split} V_{DD} &= 30 V, \ V_{GS} = 10 V \\ I_{D} &= 25 A, \ R_{g} = 3.5 \Omega \end{split}$ |
| Turn-Off Delay Time | tD(OFF) | _ | 53.5 | _ | ns | |
| Turn-Off Fall Time | t _F | _ | 32.9 | _ | | |
| Body Diode Reverse Recovery Time | trr | _ | 49.7 | _ | ns | - OF A - /- 100 A / |
| Body Diode Reverse Recovery Charge | Qrr | _ | 78.9 | _ | nC | IF = 25A, dl/dt = 100A/µs |

Notes:

^{8 .}Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to production testing.





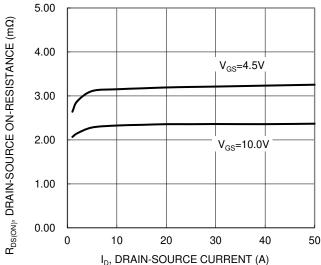


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

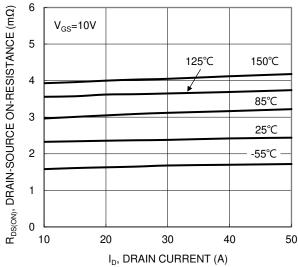
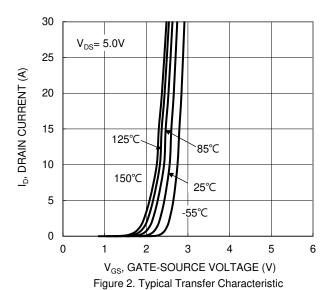
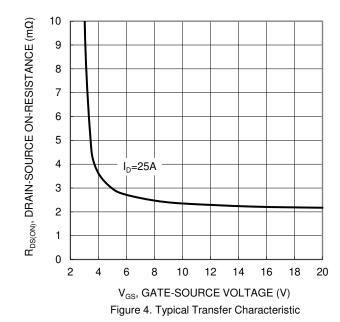
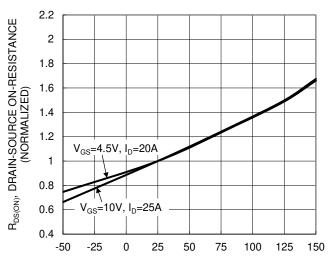


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



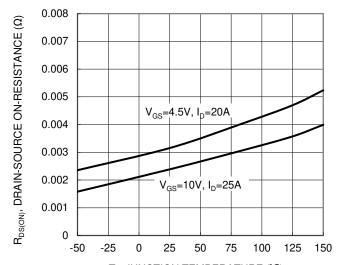




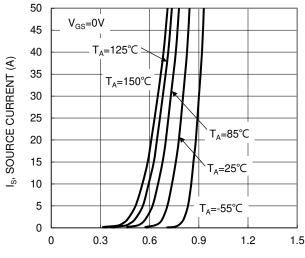
 T_J , JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature







T_., JUNCTION TEMPERATURE (°C) Figure 7. On-Resistance Variation with Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

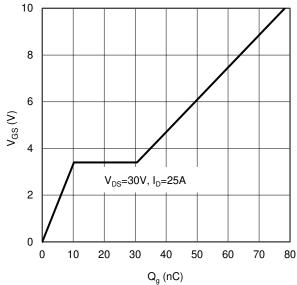


Figure 11. Gate Charge

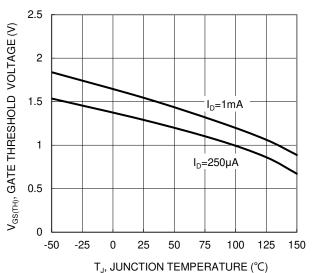
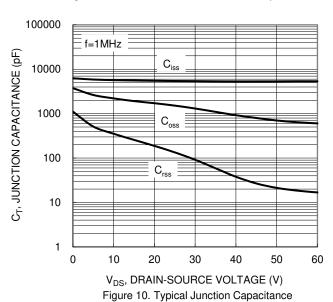


Figure 8. Gate Threshold Variation vs. Temperature



1000 R_{DS(ON)} Limited ID, DRAIN CURRENT (A) 100 P_w=10µs P_w=100μs 10 T_{J(Max)}=150°C P_w=10ms T_C=25°C P_w=100ms Single Pulse DUT on Infinite DC Heatsink V_{GS}=10V 0.1 0.1 100 V_{DS} , DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



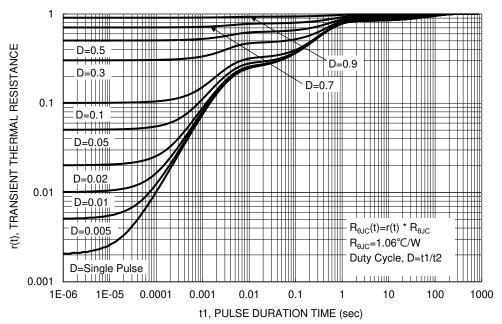


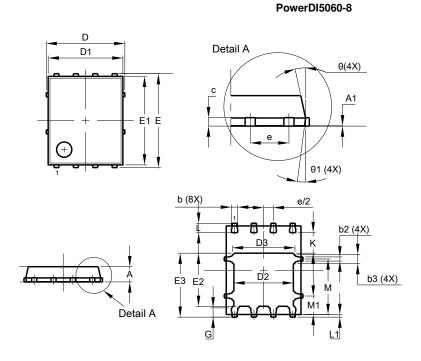
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

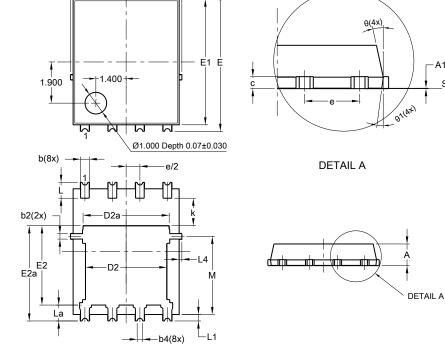


| PowerDI5060-8 | | | | |
|----------------------|-------|----------|-------|--|
| Dim | Min | Max | Тур | |
| Α | 0.90 | 1.10 | 1.00 | |
| A 1 | 0.00 | 0.05 | - | |
| b | 0.33 | 0.51 | 0.41 | |
| b2 | 0.200 | 0.350 | 0.273 | |
| b3 | 0.40 | 0.80 | 0.60 | |
| C D | 0.230 | 0.330 | 0.277 | |
| | | 5.15 BSC | | |
| D1 | 4.70 | 5.10 | 4.90 | |
| D2 | 3.70 | 4.10 | 3.90 | |
| D3 | 3.90 | 4.30 | 4.10 | |
| Е | (| 6.15 BSC | | |
| E1 | 5.60 | 6.00 | 5.80 | |
| E2 | 3.28 | 3.68 | 3.48 | |
| E3 | 3.99 | 4.39 | 4.19 | |
| e G | | 1.27 BSC | ; | |
| | 0.51 | 0.71 | 0.61 | |
| K | 0.51 | _ | - | |
| L | 0.51 | 0.71 | 0.61 | |
| L1 | 0.100 | 0.200 | 0.175 | |
| M | 3.235 | 4.035 | 3.635 | |
| M1 | 1.00 | 1.40 | 1.21 | |
| Θ | 10° | 12° | 11° | |
| Θ1 | 6° | 8° | 7° | |
| All Dimensions in mm | | | | |
| | | | | |

Site 2:

PowerDI5060-8/SWP (Type UX)

Seating Plane



| PowerDI5060-8/SWP | | | | |
|----------------------|----------|---------|-------|--|
| (Type UX) | | | | |
| Dim | Min | Max | Тур | |
| Α | 0.90 | 1.10 | 1.00 | |
| A 1 | 0 | 0.05 | | |
| b | 0.30 | 0.50 | 0.41 | |
| b2 | 0.20 | 0.35 | 0.25 | |
| b4 | C |).25REF | | |
| С | 0.230 | 0.330 | 0.277 | |
| D | | .15 BS0 | | |
| D1 | 4.70 | 5.10 | 4.90 | |
| D2 | 3.56 | 3.96 | 3.76 | |
| D2a | 3.78 | 4.18 | 3.98 | |
| E | 6 | .40 BS0 | | |
| E1 | 5.60 | 6.00 | 5.80 | |
| E2 | 3.46 | 3.86 | 3.66 | |
| E2a | 4.195 | 4.595 | 4.395 | |
| е | 1.27BSC | | | |
| k | 1.05 | | | |
| L | 0.635 | 0.835 | 0.735 | |
| La | 0.635 | 0.835 | 0.735 | |
| L1 | 0.200 | 0.400 | 0.300 | |
| L1a | 0.050REF | | | |
| L4 | 0.025 | 0.225 | 0.125 | |
| М | 3.205 | 4.005 | 3.605 | |
| θ | 10° | 12° | 11° | |
| θ1 | 6° | 8° | 7° | |
| All Dimensions in mm | | | | |

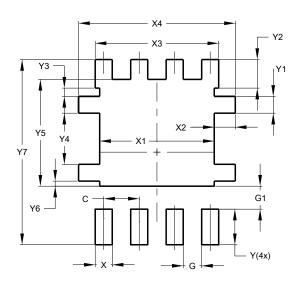


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

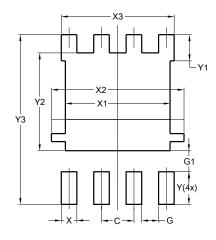
PowerDI5060-8



| Dimensions | Value (in mm) | | |
|------------|---------------|--|--|
| С | 1.270 | | |
| G | 0.660 | | |
| G1 | 0.820 | | |
| X | 0.610 | | |
| X1 | 4.100 | | |
| X2 | 0.755 | | |
| Х3 | 4.420 | | |
| X4 | 5.610 | | |
| Υ | 1.270 | | |
| Y1 | 0.600 | | |
| Y2 | 1.020 | | |
| Y3 | 0.295 | | |
| Y4 | 1.825 | | |
| Y5 | 3.810 | | |
| Y6 | 0.180 | | |
| Y7 | 6.610 | | |

Site 2:

PowerDI5060-8/SWP (Type UX)



| Dimensions | Value (in mm) | |
|------------|------------------|--|
| С | 1.270 | |
| G | 0.660 | |
| G1 | 0.820 | |
| Х | 0.610 | |
| X1 | 4.100 | |
| X2 | 5.190 | |
| Х3 | 4.420 | |
| Υ | 1.270 | |
| Y1 | 1.020 | |
| Y2 | 3.810 | |
| Y3 | 6.610 | |



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